



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



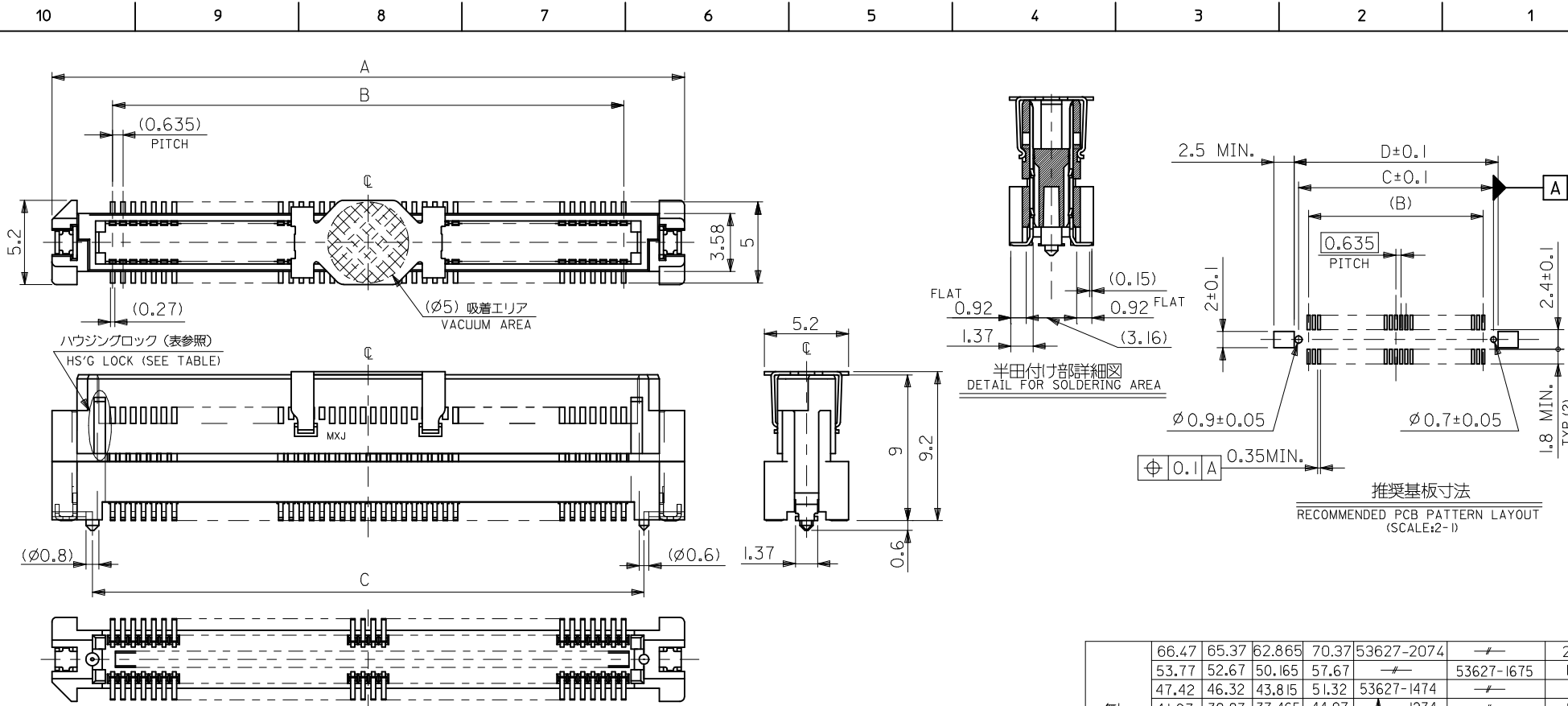
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NOTES

1. 材質

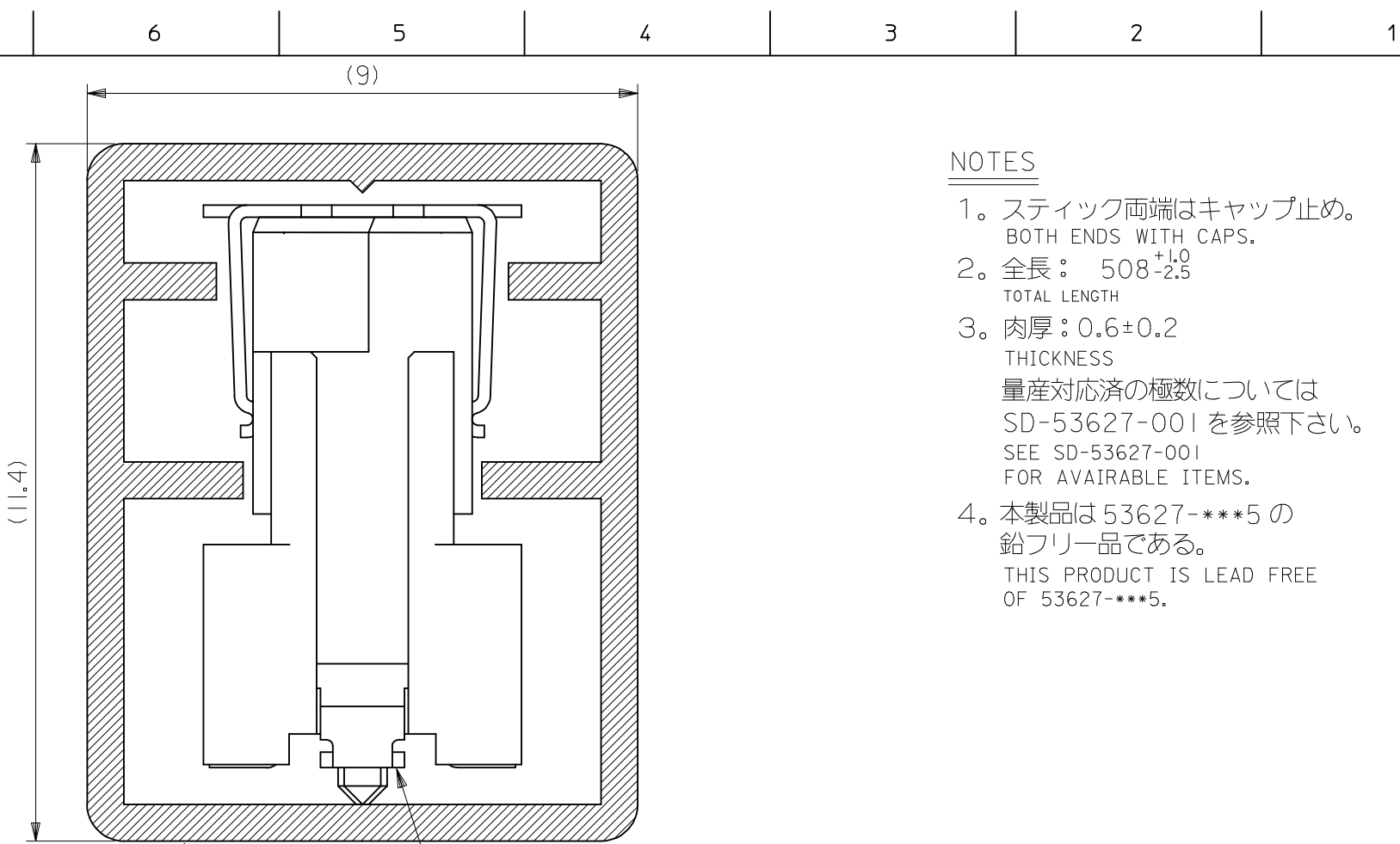
MATERIAL
 ハウジング: ガラス入りPPS、茶色、UL94V-0
 HOUSING: POLYPHENYLENE SULFIDE, GLASS FILLED, BROWN, UL94V-0
 ターミナル: 銅合金 (t=0.2)、ニッケルメッキ下地1.5マイクromメートル以上
 TERMINAL: COPPER ALLOY, UNDER-PLATING: NICKEL 1.5 MICROMETER MIN.
 接点部 : 金メッキ 0.25マイクromメートル以上
 CONTACT AREA: GOLD 0.25 MICROMETER MIN.
 半田付け部 : 錫メッキ1.0マイクromメートル以上
 SOLDER TAIL AREA: TIN 1.0 MICROMETER MIN.
 ネール : リン青銅(t=0.2)、ニッケルメッキ下地1.0マイクromメートル以上
 NAIL: PHOSPHOR BRONZE, UNDER-PLATING: NICKEL 1.0 MICROMETER MIN.
 錫メッキ1.0マイクromメートル以上
 TIN 1.0 MICROMETER MIN.
 吸着カバー: ステンレス (t=0.2)
 VACUUM COVER: STAINLESS STEEL

2. テールのバラツキ寸法

TAIL COPLANARITY
 テール平坦度は、0.1ミリ以下とする。
 TAILS COPLANARITY TO BE 0.1 MILLIMETER MAX.

無し NO	66.47	65.37	62.865	70.37	53627-2074	—	200
	53.77	52.67	50.165	57.67	—	53627-1675	160
	47.42	46.32	43.815	51.32	53627-1474	—	140
	41.07	39.97	37.465	44.97	-1274	—	120
	34.72	33.62	31.115	38.62	-1074	—	100
有り YES	31.55	30.45	27.94	35.45	-0974	—	90
	28.37	27.27	24.765	32.27	-0874	—	80
	25.2	24.1	21.59	29.1	-0774	—	70
	22.02	20.92	18.415	25.92	-0674	—	60
	18.85	17.75	15.24	22.75	-0574	—	50
ハウジングロック HSG LOCK	15.67	14.57	12.065	19.57	-0474	—	40
	12.5	11.4	8.89	16.4	-0374	—	30
	9.32	8.22	5.715	13.22	53627-0274	—	20
	D	C	B	A	エンボス梱包 EMBOSSED PACKAGE	スティック梱包 STICK PACKAGE	極数 CIRCUITS
	CONNECTOR SERIES No.					53627-**72	

REVISED EC NO: J2017-0317 DRWN: KNO2 CHKD: APPR: MSASAO	2016/12/15	2017/03/15	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	
	DESCRIPTION		0.25 UNDER	±0.03	DRAWN BY	DATE	TITLE				
			0.25 OVER	0.5 UNDER	±0.05	Y. SAKIYAMA	2004/03/05	0.635 PITCH B/B CONN. PLUG HSG COVER ASSY -LEAD FREE-			
			0.5 OVER	0 UNDER	±0.1	M. SASAO	2004/03/05				
		10 OVER	10 UNDER	±0.2	APPROVED BY		molex				
		30 OVER		±0.3	M. SASAO						SD-53627-001
		ANGULAR		±3 °	MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



NOTES

1. スティック両端はキャップ止め。
BOTH ENDS WITH CAPS.
2. 全長: $508^{+1.0}_{-2.5}$
TOTAL LENGTH
3. 肉厚: 0.6 ± 0.2
THICKNESS
量産対応済の極数については
SD-53627-001 を参照下さい。
SEE SD-53627-001
FOR AVAIRABLE ITEMS.
4. 本製品は 53627-***5 の
鉛フリー品である。
THIS PRODUCT IS LEAD FREE
OF 53627-***5.

スティック
STICK

53627-***72
CONN.

MODEL NO.	53627-***75	梱包数量 QUANTITY	8	MATERIAL NO.	53627-1675	極数 CIRCUITS	160
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MATERIAL
スティック: ポリ塩化ビニル
STICK: P.V.C

REVISED EC NO: J2017-0317 DRAWN: MKN02 CHKD: APPR: MSASAO 2016/12/21 2017/03/15 DESCRIPTION REV A	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	0.25 UNDER	±0.03	DRAWN BY Y. SAKIYAMA		DATE 04/03/05	TITLE STICK PACKAGE FOR 53627-***72 -LEAD FREE-	
	0.25 OVER 0.5 UNDER	±0.05	CHECKED BY M. SASAO		DATE 04/03/05		
	0.5 OVER 1.0 UNDER	±0.1	APPROVED BY M. SASAO		DATE 04/03/05		
	1.0 OVER 10 UNDER	±0.2	MATERIAL NO.		DOCUMENT NO.	SHEET NO.	
	10 OVER 30 UNDER	±0.25	SEE CHART		SD-53627-003	1 OF 1	
30 OVER	±0.3	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A4	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

molex